

New Product

P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$r_{DS(on)}\left(\Omega\right)$	I _D (A)		
- 20	0.0073 at $V_{GS} = -4.5 \text{ V}$	- 20		
	$0.0090 \text{ at V}_{GS} = -2.5 \text{ V}$	– 18		
	0.013 at V _{GS} = - 1.8 V	– 15		

PowerPAK SO-8

FEATURES

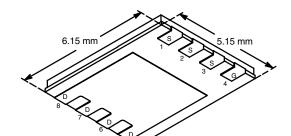
- TrenchFET[®] Power MOSFET
- New Low Thermal Resistance PowerPAK[®] Package with Low 1.07-mm Profile



RoHS

APPLICATIONS

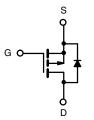
· Battery Switch for Portable Devices



Bottom View

Ordering Information: Si7485DP-T1

Si7485DP-T1—E3 (Lead (Pb)-free)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS \top	$_A = 25 ^{\circ}\text{C}$, unles	ss otherwise r	noted		
Parameter		Symbol	10 secs	Steady State	Unit
Drain-Source Voltage		V_{DS}	- 20		V
Gate-Source Voltage		V_{GS}	± 8		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 25 °C	- I _D	- 20	- 12.5	
Continuous Diain Current (1) = 150 °C)	T _A = 70 °C		- 16.5	- 9.5	٨
Pulsed Drain Current		I _{DM}	- 50		Α
Continuous Source Current (Diode Conduction) ^a		I _S	- 4.5	- 1.6	
Maximum Dawar Dissination	T _A = 25 °C	P _D	5	1.8	W
Maximum Power Dissipation ^a	T _A = 70 °C		3.2	1.1	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	– 55 to 150		°C
Soldering Recommendations (Peak Temperature) ^{b,c}			260		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manimum lumation to Ambrianti	t ≤ 10 sec	R _{thJA}	20	25	
Maximum Junction-to-Ambient ^a	Steady State		54	68	°C/W
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	1.7	2.2	

Notes

a. Surface Mounted on 1" x 1" FR4 Board.

b. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

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c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.

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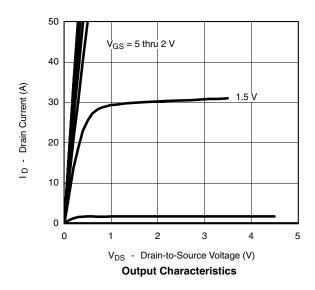


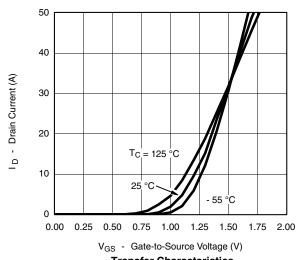
SPECIFICATIONS $T_J = 25$ °C, unless otherwise noted								
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit		
Static								
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -1$ mA	- 0.4		- 0.9	V		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -20 V, V _{GS} = 0 V			– 1			
		$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$			- 10	μΑ		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 40			Α		
Drain-Source On-State Resistance ^a		$V_{GS} = -4.5 \text{ V}, I_D = -20 \text{ A}$		0.006	0.0073			
	r _{DS(on)}	$V_{GS} = -2.5 \text{ V}, I_D = -18 \text{ A}$		0.0074	0.0090	Ω		
		$V_{GS} = -1.8 \text{ V}, I_D = -15 \text{ A}$		0.0106	0.013			
Forward Transconductance ^a	9 _{fs}	$V_{DS} = -15 \text{ V}, I_{D} = -20 \text{ A}$		80		S		
Diode Forward Voltage ^a	V_{SD}	$I_S = -4.5 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.62	- 1.1	V		
Dynamic ^b								
Total Gate Charge	Q_g			99	150			
Gate-Source Charge	Q _{gs} Q _{gd}	$V_{DS} = -10 \text{ V}, V_{GS} = -5 \text{ V}, I_D = -20 \text{ A}$		11.5		nC		
Gate-Drain Charge				29				
Gate Resistance	R_{g}			2.4		Ω		
Turn-On Delay Time	t _{d(on)}			80	120			
Rise Time	t _r	$V_{DD} = -10 \text{ V}, R_L = 10 \Omega$		140	210			
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ $-$ 1 A, V_{GEN} = $-$ 4.5 V, R_G = 6 Ω		360	540	ns		
Fall Time	t _f			170	260			
Source-Drain Reverse Recovery Time	t _{rr}	$I_F = -2.9 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s}$		55	80			

Notes a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless noted



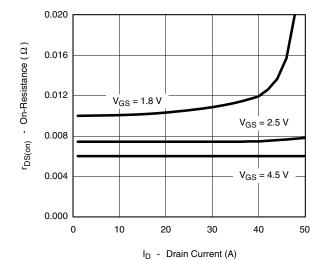


Transfer Characteristics

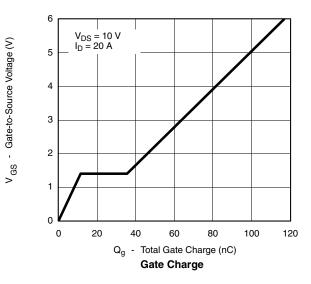


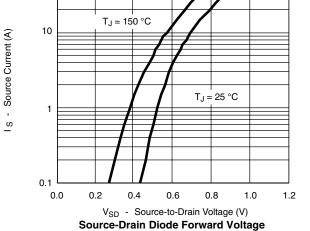
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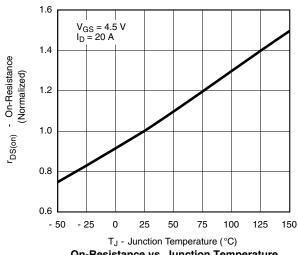
On-Resistance vs. Drain Current



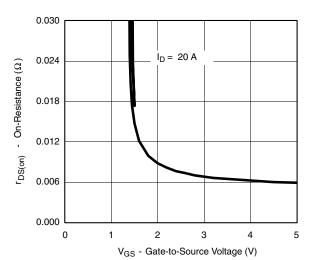


11000 8800 C - Capacitance (pF) C_{iss} 6600 4400 2200 C_{rss} 0 0 12 16 20

V_{DS} - Drain-to-Source Voltage (V) Capacitance



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

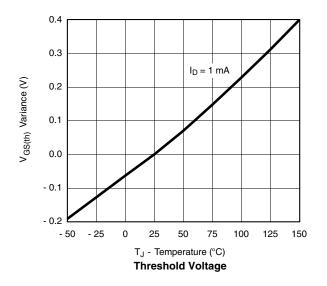
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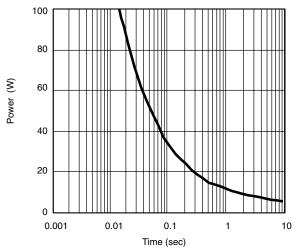
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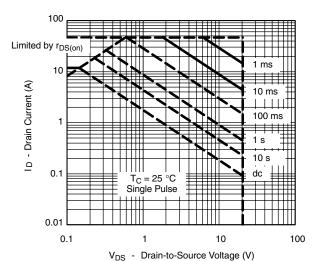


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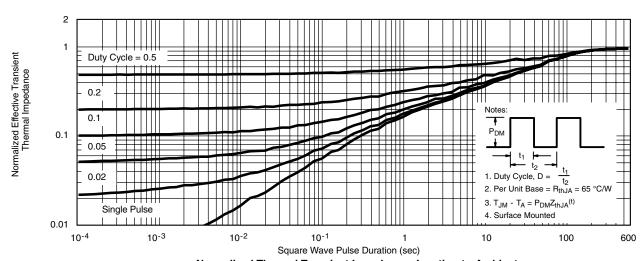




Single Pulse Power, Junction-to-Ambient



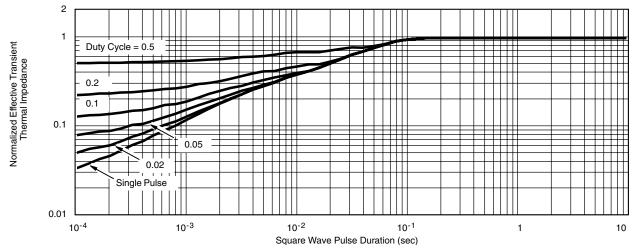
Safe Operating Area, Junction-to-Case



Normalized Thermal Transient Impedance, Junction-to-Ambient

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TYPICAL CHARACTERISTICS 25 °C, unless noted



Normalized Thermal Transient Impedance, Junction-to-Case

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